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PATENT
000939-072310US
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On June 28, 2001
TOWNSEND and TOWNSEND and CREW LLP

By: Sherry Barton

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Do-Young Lee

Application No.: 09/780,682

Filed: February 8, 2001

For: PIXEL LAYOUT FOR CMOS
IMAGE SENSOR

Examiner: Not Yet Assigned

Art Unit: 2612

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

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Technology Center 2600

Sir:

Prior to examination of the above-referenced application, please enter the following
amendments and remarks.

IN THE SPECIFICATION:

On the cover page of the application, please replace the address of the Assignee with
the following address, which is consistent with the address of the Assignee in the Assignment
submitted for recordation:

HYUNDAI ELECTRONICS INDUSTRIES, LTD.
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Kyoungki-Do 467-860
REPUBLIC OF KOREA

Do-Young Lee
Application No.: 09/780,682
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PATENT



Respectfully submitted,

A handwritten signature in black ink, appearing to read "William E. Winters".

William E. Winters
Reg. No. 42,232

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